

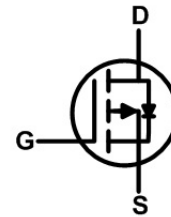
➤ General Description

This PAP26TD31DA P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent $R_{ds(On)}$ performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➤ Feature

- Green Device Available
- Super Low Gate Charge
- 100% EAS Guaranteed
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology
- DFN3.3x3.3-8L package design

➤ DFN3.3x3.3-8L



➤ Application

- DC/DC Primary Side Switch
- Industrial Synchronous
- Rectification Load Switch
- DC/DC Converters

➤ Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ¹	$I_D@T_C=25^\circ C$	-50	A
Continuous Drain Current ¹	$I_D@T_C=100^\circ C$	-39	A
Pulsed Drain Current ²	I_{DM}	-200	A
Single Pulse Avalanche Energy ³	EAS	80	mJ
Avalanche Current	I_{AS}	40	A
Total Power Dissipation ⁴	$P_D@T_C=25^\circ C$	83	W
Storage Temperature Range	T_{STG}	-55 to 150	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to 150	$^\circ C$
Thermal Resistance Junction-ambient ¹ ($t \leq 10S$)	$R_{\theta JA}$	20	$^\circ C/W$
Thermal Resistance Junction-ambient ¹ (Steady State)		55	$^\circ C/W$
Thermal Resistance Junction-case ¹	$R_{\theta JC}$	1.5	$^\circ C/W$

➤ Electrical Characteristics ($T_J=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-20	---	---	V
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-20A$	---	3.6	5	$m\Omega$
		$V_{GS}=-2.5V, I_D=-20A$	---	4.7	6.5	$m\Omega$
		$V_{GS}=-1.8V, I_D=-20A$	---	6.4	8.5	$m\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-0.35	-0.5	-1.0	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-16V, V_{GS}=0V, T_J=25^\circ C$	---	---	-1	μA
		$V_{DS}=-16V, V_{GS}=0V, T_J=125^\circ C$	---	---	-5	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$	---	---	± 100	nA
Gate Resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	---	5	---	Ω
Total Gate Charge (10V)	Q_g	$V_{DS}=-15V, V_{GS}=-10V, I_D=-20A$	---	76	---	nC
Gate-Source Charge	Q_{gs}		---	9	---	
Gate-Drain Charge	Q_{gd}		---	13.7	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-15V, V_{GS}=-10V, R_G=3\Omega, I_D=-20A$	---	12	---	ns
Rise Time	T_r		---	10.7	---	
Turn-Off Delay Time	$T_{d(off)}$		---	55.4	---	
Fall Time	T_f		---	15.2	---	
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V, f=1MHz$	---	4307	---	pF
Output Capacitance	C_{oss}		---	501	---	
Reverse Transfer Capacitance	C_{rss}		---	321	---	

➤ Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current ^{1,5}	I_S	$V_G=V_D=0V, \text{ Force Current}$	---	---	-50	A
Diode Forward Voltage ²	V_{SD}	$V_{GS}=0V, I_S=-1A, T_J=25^\circ C$	---	---	-1.2	V
Reverse Recovery Time	t_{rr}	$I_F=-20A, di/dt=100A/\mu s,$	---	55	---	nS
Reverse Recovery Charge	Q_{rr}	$T_J=25^\circ C$	---	365	---	nC

Note :

1. Pulse width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating . The test condition is $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-40A$
4. Ensure that the channel temperature does not exceed $150^\circ C$.
5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

➤ Typical Characteristics

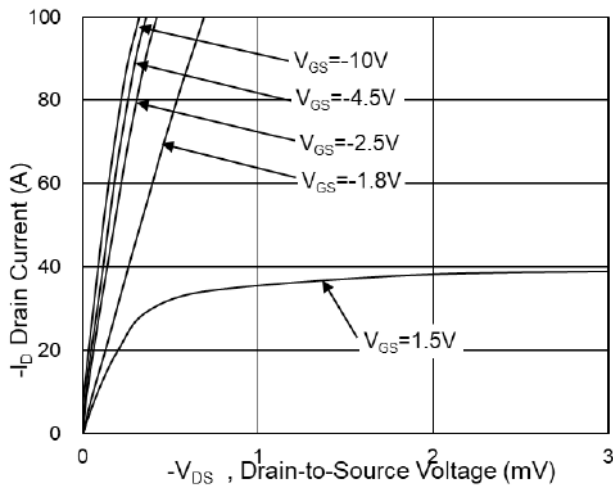


Fig.1 Typical Output Characteristics

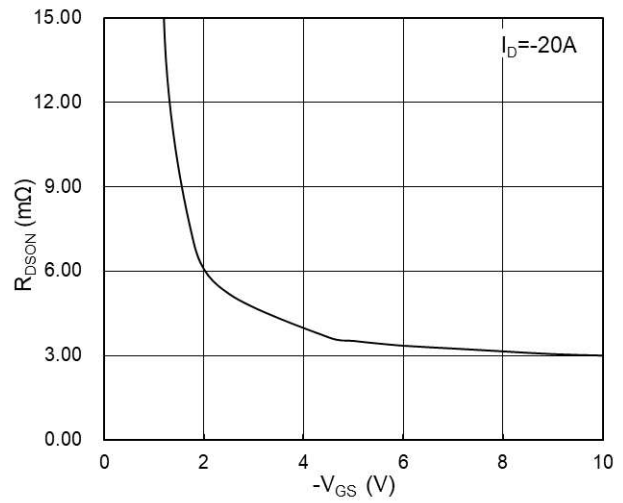


Fig.2 On-Resistance vs G-S Voltage

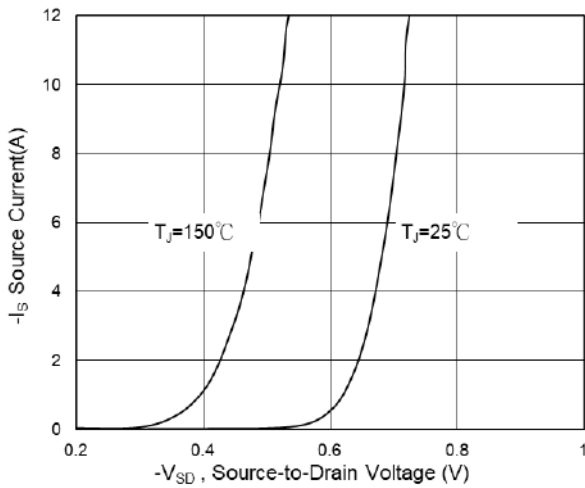


Fig.3 Source Drain Forward Characteristics

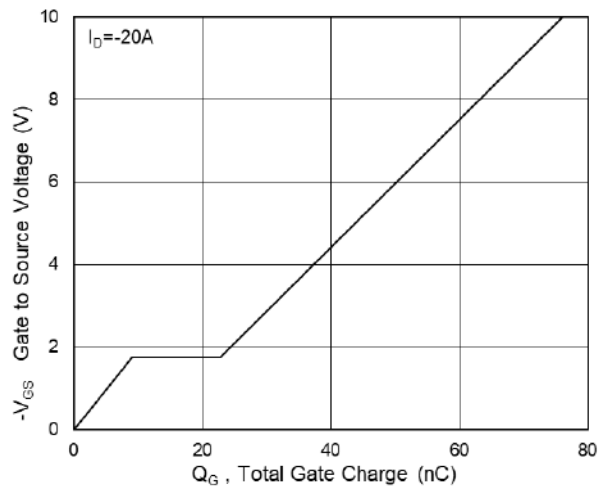


Fig.4 Gate-Charge Characteristics

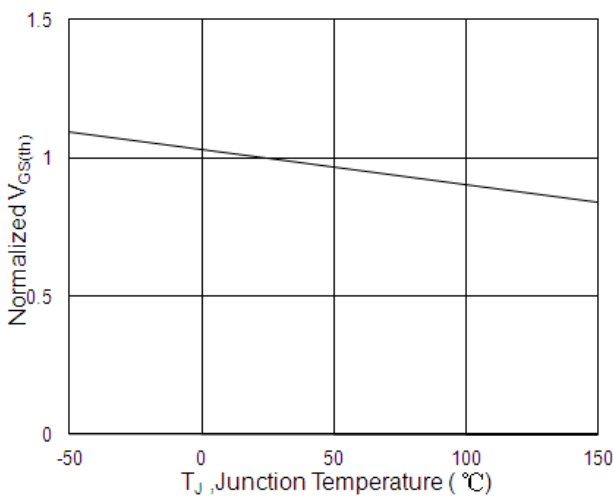


Fig.5 Normalized $V_{GS(th)}$ vs T_J

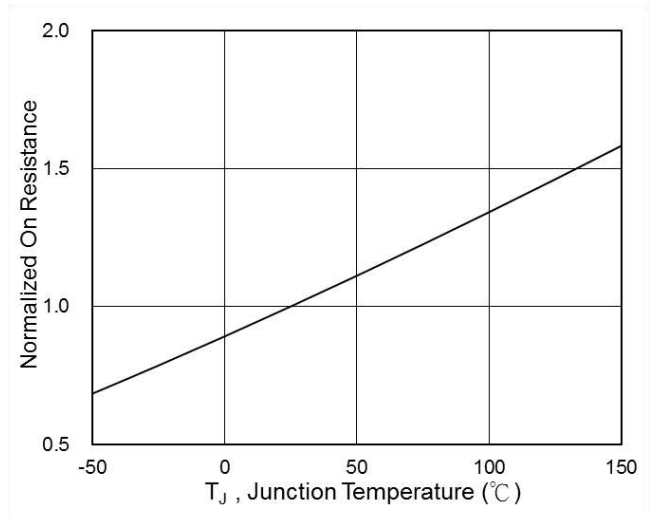


Fig.6 Normalized $R_{DS(ON)}$ vs T_J

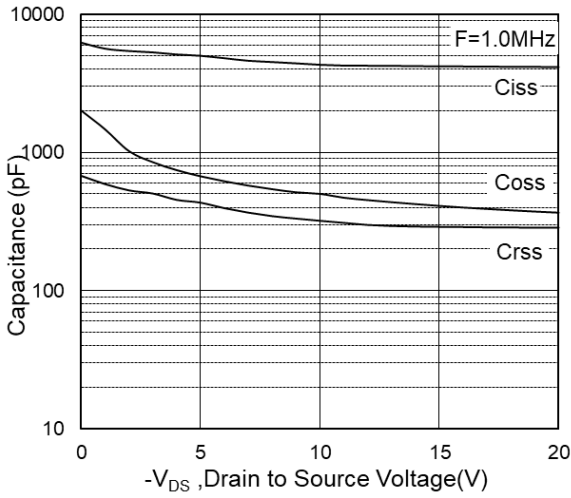


Fig.7 Capacitance

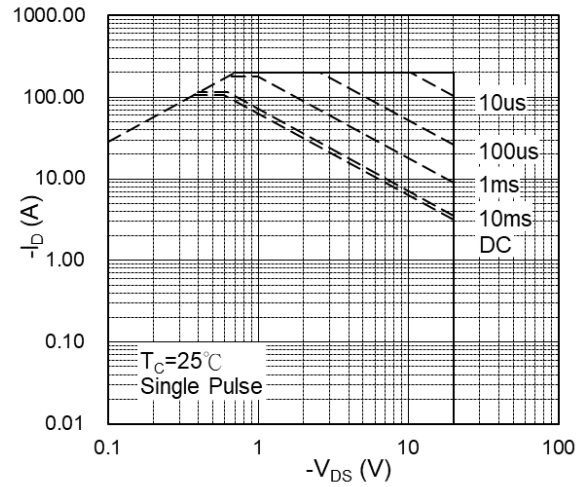


Fig.8 Safe Operating Area

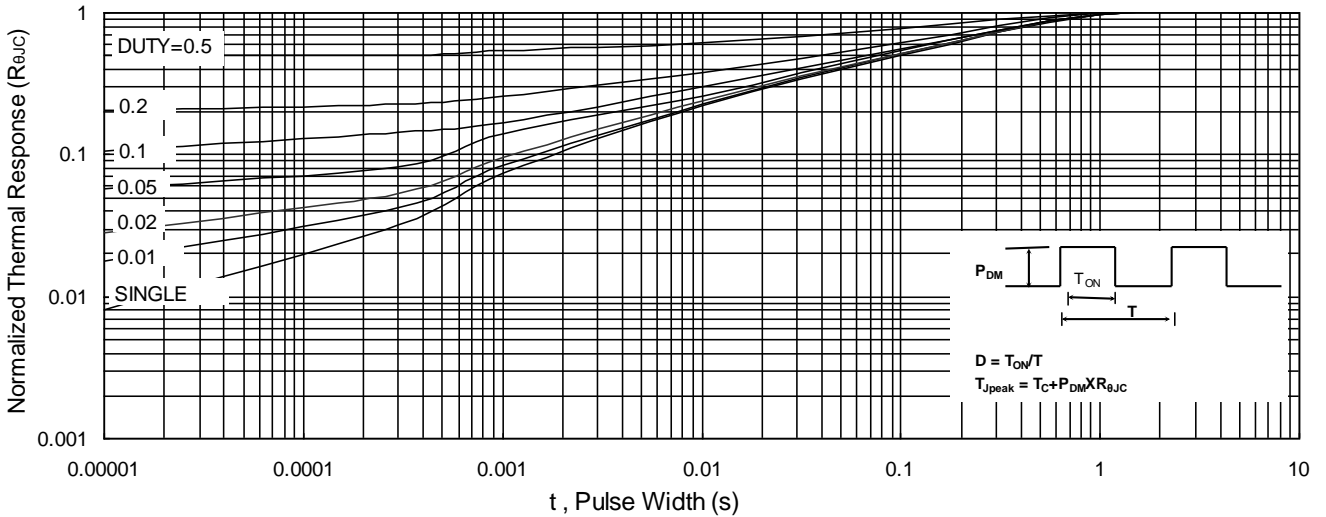


Fig.9 Normalized Maximum Transient Thermal Impedance

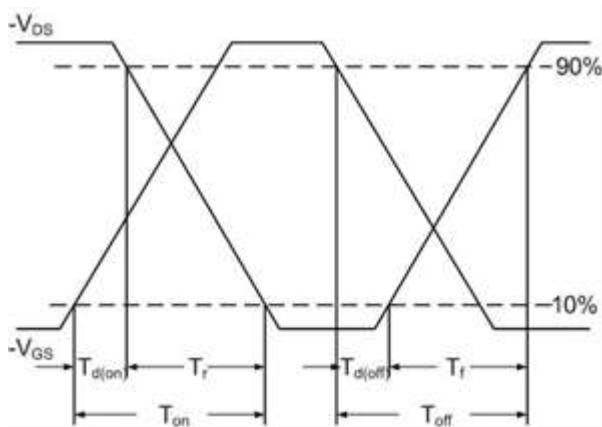


Fig.10 Switching Time Waveform

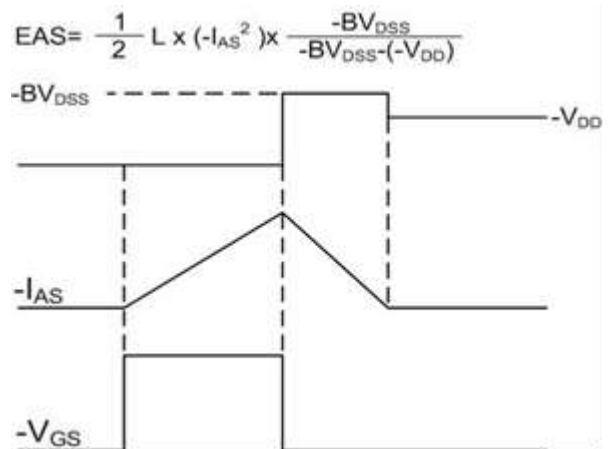


Fig.11 Unclamped Inductive Switching Waveform

➤ Recommand IR Reflow Soldering Thermal Profile

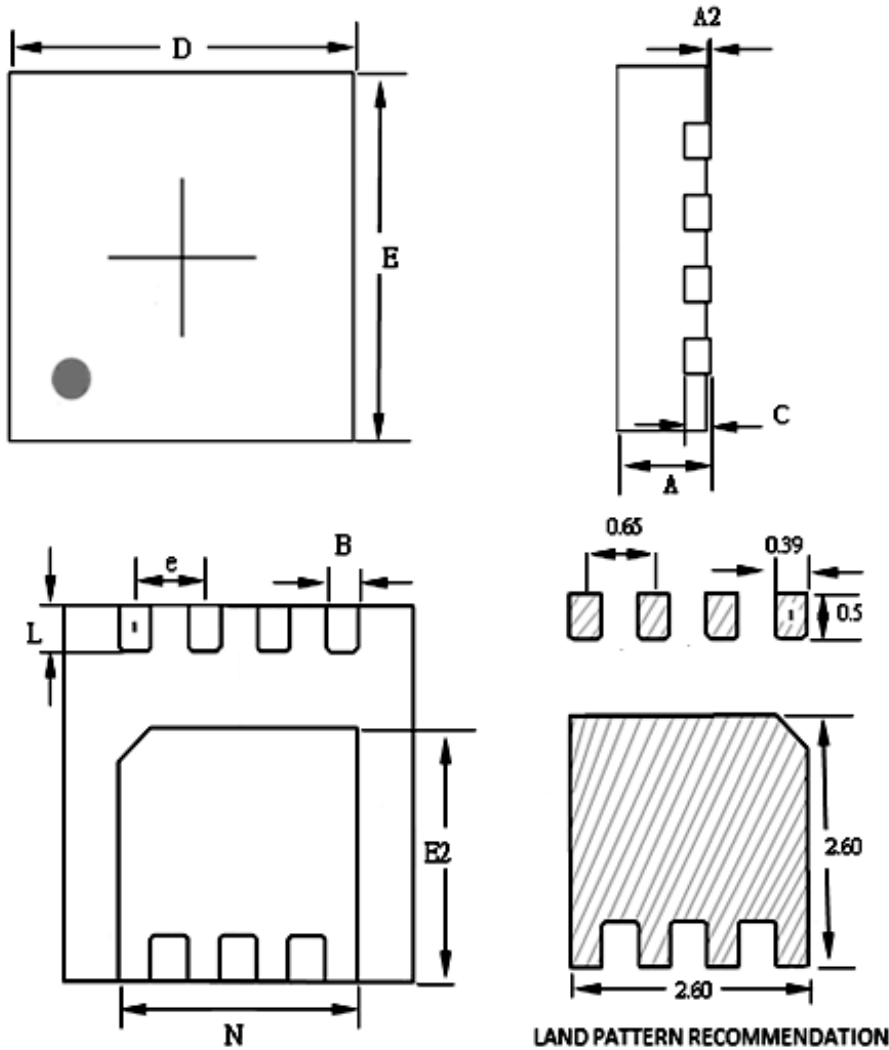


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150°C
Temperature Max. (T _{smax})	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Average Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

Part Number	Description	Quantity
PAP26TD31DA	DFN3.3x3.3-8L Reel	3000 pcs

➤ Package Information (DFN3.3X3.3-8L)



SYMBOLS	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.031
A2	0.00	--	0.05	0.000	--	0.002
B	0.24	0.30	0.35	0.009	0.012	0.014
C	0.10	0.15	0.25	0.004	0.006	0.010
D	3.15	3.30	3.40	0.124	0.130	0.134
E	3.15	3.30	3.40	0.124	0.130	0.134
E2	2.15	2.25	2.35	0.085	0.089	0.093
L	0.35	0.40	0.45	0.014	0.016	0.018
N	2.10	2.25	2.35	0.083	0.089	0.093
e	--	0.65	--	--	0.026	--

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